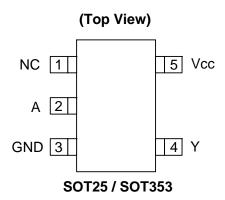


Description

The 74LVCE1G07 is a single buffer with an open drain output. The device is designed for operation with a power supply range of 1.4V to 5.5V. The input is tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down. The open-drain output can be connected to other open drain outputs to implement active-low wired-OR or active-high wired-AND functions. The maximum sink current is 32 mA.

Pin Assignments



Features

- Extended Supply Voltage Range from 1.4 to 5.5V
- Switching speed characterized for operation at 1.5V
- Offers 30% speed improvement over LVC at 1.8V.
- 24mA Output Drive at 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Exceeds JESD 22
- 200-V Machine Model (A115-A)
- 2000-V Human Body Model (A114-A)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Direct Interface with TTL Levels
- SOT25 and SOT353: Available in "Green" Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- · Wide array of products such as.
 - PCs, networking, notebooks, netbooks, PDAs
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box
 - · Cell Phones, Personal Navigation / GPS
 - MP3 players ,Cameras, Video Recorders

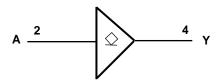
Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.



Pin Descriptions

Pin Name	Pin NO.	Description	
NC	1	No connection	
Α	2	Data Input	
GND	3	Ground	
Y	4	Data Output Open Drain	
Vcc	5	Supply Voltage	

Logic Diagram



Function Table

Inputs	Output
Α	Υ
Н	Z
L	L



Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
Vı	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
V _o	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I <0	-50	mA
I _{OK}	Output Clamp Current	-50	mA
Io	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
T _J	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



Recommended Operating Conditions (Note 3)

Symbol		Parameter	Min	Max	Unit	
	On a ratio a Valta as	Operating	1.4	5.5	V	
V _{CC}	Operating Voltage	Data retention only	1.2		V	
		V _{CC} = 1.4 V to 1.95 V	0.65 X V _{CC}			
\/	High level lengt Voltage	V _{CC} = 2.3 V to 2.7 V	1.7		V	
V _{IH}	High-level Input Voltage	V _{CC} = 3 V to 3.6 V	2		V	
		V _{CC} = 4.5 V to 5.5 V	0.7 X V _{CC}			
		V _{CC} = 1.4 V to 1.95 V		0.35 X V _{CC}		
\/	Low lovel input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	.,	
V _{IL}	V _{IL} Low-level input voltage	V _{CC} = 3 V to 3.6 V		0.8	V	
		$V_{CC} = 4$	V _{CC} = 4.5 V to 5.5 V		0.3 X V _{CC}	
Vı	Input Voltage		0	5.5	V	
Vo	Output Voltage		0	V _{CC}	V	
		Vcc=1.4 V		3		
		V _{CC} = 1.65 V		4	mA	
	Lave lavel autout aumant	V _{CC} = 2.3 V		8		
I _{OL}	Low-level output current	V 2V		16		
		$V_{CC} = 3 V$		24		
		V _{CC} = 4.5 V		32		
		V _{CC} = 1.4 V to 3.0 V		20		
Δt/ΔV	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		10	ns/V	
	iaic	$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$		5		
T _A	Operating free-air temperature		-40	85	°C	

Notes: 3. Unused inputs should be held at Vcc or Ground.



Electrical Characteristics (All typical values are at Vcc = 3.3V, T_A = 25°C)

Over recommended free-air temperature range (unless otherwise noted)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit
		I _{OL} = 100 μA	1.4 V to 5.5 V			0.1	
		I _{OL} = 3 mA	1.4 V			0.4	
		I _{OL} = 4 mA	1.65 V			0.45	
V_{OL}	Low Level Output Voltage	I _{OL} = 8 mA	2.3 V			0.3	V
	Catput Voltago	I _{OL} = 16 mA	3 V			0.4	v
		I _{OL} = 24 mA	3 V			0.55	
		I _{OL} = 32 mA	4.5 V			0.55	
l _l	Input Current	V _I = 5.5 V or GND	0 to 5.5 V			± 1	μΑ
l _{OZ}	Z State Leakage Current	V _O = 5.5V	3.6 V			± 10	μΑ
I _{OFF}	Power Down Leakage Current	V_1 or $V_0 = 5.5V$	0 V			± 10	μA
I _{cc}	Supply Current	$V_1 = 5.5 \text{ V or GND } I_0 = 0$	1.4 V to 5.5 V			10	μA
ΔI_{CC}	Additional Supply Current	Input at V _{CC} -0.6 V	3 V to 5.5 V			500	μA
Ci	Input Capacitance	V _I = V _{CC} or GND	3.3V		4		pF
Co	Output Capacitance	V _O = V _{CC} or GND	3.3V		5		pF
0	Thermal Resistance	SOT25	(Note 4)		204		
θ_{JA}	Junction-to-Ambient	SOT353	(Note 4)		371		°C // //
0	Thermal Resistance	SOT25	(Note 4)		52		°C/W
θ_{JC}	Junction-to-Case	SOT353	(Note 4)		143		

Notes: 4. Test condition for SOT25 and SOT353: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Switching Characteristics

Over recommended free-air temperature range, CL = 15pF (see Figure 1)

Parameter	From	то	Vcc = ± 0.			: 1.8 V .15V		: 2.5 V).2V		3.3 V 3.3 V		= 5 V).5V	Unit
(Input)	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
t _{pd}	A	Υ	1.5	9.9	1	5.8	0.8	4.4	0.8	3.4	0.8	3.1	ns

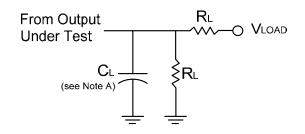
Operating Characteristics

 $T_A = 25 \, {}^{\circ}C$

P	arameter	Test Conditions	Vcc = 1.5 V TYP	Vcc = 1.8 V TYP	Vcc = 2.5 V TYP	Vcc = 3.3 V TYP	Vcc = 5 V	Unit
$C_{\sf pd}$	Power dissipation capacitance	f = 10 MHz	3	3	3	4	6	pF



Parameter Measurement Information



TEST	Condition
t _{PLZ} (see Notes D and E)	Vload
t _{PZL} (see Notes D and F)	Vload

Vcc	Inp	uts	V _M	V _{LOAD}	CL	RL	V Δ
	VI	t _r /t _f	- 101	LOAD			
1.5V±0.1V	V _{cc}	≤2ns	V _{CC} /2	2 X V _{CC}	30pF	1ΚΩ	0.15V
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	2 X V _{CC}	30pF	1ΚΩ	0.15V
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	2 X V _{CC}	30pF	500Ω	0.15V
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V
5V±0.5V	V _{CC}	≤2.5ns	V _{CC} /2	2 X V _{CC}	50pF	500Ω	0.3V

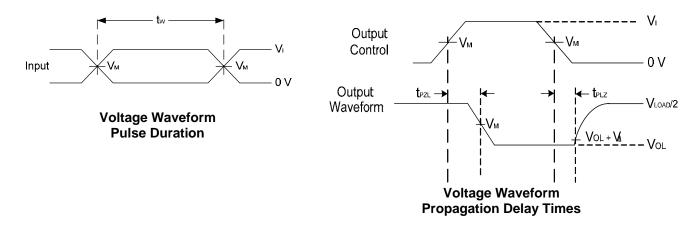


Figure 1. Load Circuit and Voltage Waveforms

Notes: A. Includes test lead and test apparatus capacitance.

B. All pulses are supplied at pulse repetition rate ≤ 10 MHz

C. The inputs are measured one at a time with one transition per measurement.

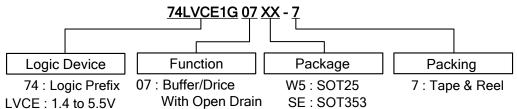
D. For the open drain device t_{PLZ} and t_{PZL} are the same as t_{PD}

E. t_{PZL} is measured at V_M .

F. t_{PLZ} is measured at $V_{OL} + V_{\Delta}$



Ordering Information



LVCE: 1.4 to 5.5V Family

Family 1G : One gate

Device	Package	Packaging	7" Tape a	nd Reel
Device	Code	(Note 5)	Quantity	Part Number Suffix
74LVCE1G07W5-7	W5	SOT25	3000/Tape & Reel	-7
74LVCE1G07SE-7	SE	SOT353	3000/Tape & Reel	-7

Notes: 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Marking Information

(Top View)

5 4 <u>XX Y W X</u>

XX: Identification code

Y: Year 0~9

W: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week

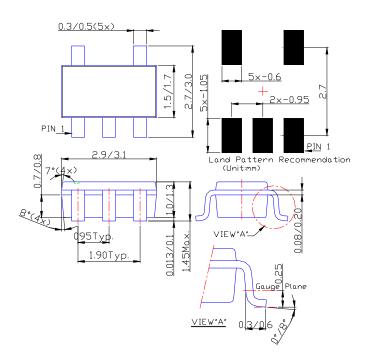
X: A~Z: Internal code

Part Number	Package	Identification Code
74LVCE1G07W5	SOT25	PN
74LVCE1G07SE	SOT353	PN

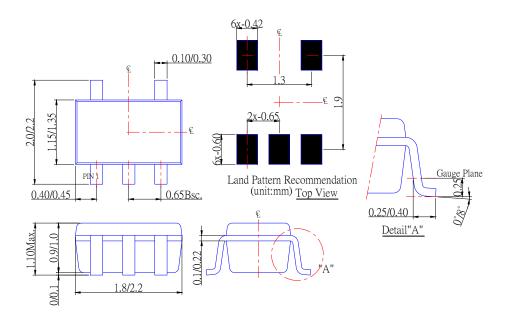


Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SOT25



(2) Package Type: SOT353





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